
HD74LVC32

Quad. 2-input OR Gates

HITACHI

ADE-205-065B(Z)

Rev.2

September 1995

Description

The HD74LVC32 has four 2-input OR gates in a 14 pin package. Low voltage and high speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{CC} = 2.0\text{ V to }5.5\text{ V}$
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V} (@V_{CC} = 0\text{ V to }5.5\text{ V})$
- Typical V_{OL} ground bounce $< 0.8\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- Typical V_{OH} undershoot $> 2.0\text{ V} (@V_{CC} = 3.3\text{ V}, T_a = 25^\circ\text{C})$
- High output current $\pm 24\text{ mA} (@V_{CC} = 3.0\text{ V to }5.5\text{ V})$

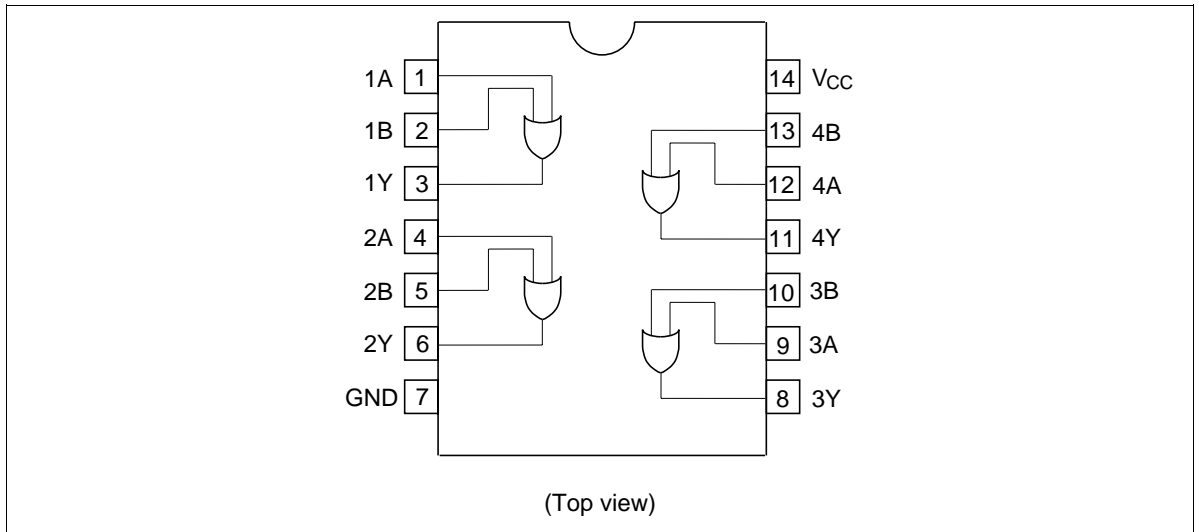
Function Table

Inputs		Output Y
A	B	
L	L	L
H	L	H
L	H	H
H	H	H

H : High level

L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V_{CC}	-0.5 to 6.0	V	
Input diode current	I_{IK}	-50	mA	$V_I = -0.5\text{ V}$
Input voltage	V_I	-0.5 to 6.0	V	
Output diode current	I_{OK}	-50	mA	$V_O = -0.5\text{ V}$
		50	mA	$V_O = V_{CC} + 0.5\text{ V}$
Output voltage	V_O	-0.5 to $V_{CC} + 0.5$	V	
Output current	I_O	± 50	mA	
V_{CC} , GND current / pin	I_{CC} or I_{GND}	100	mA	
Storage temperature	Tstg	-65 to +150	$^{\circ}\text{C}$	

Note: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	1.5 to 5.5	V	Data retention
		2.0 to 5.5	V	At operation
Input / Output voltage	V_I	0 to 5.5	V	A, B
	V_O	0 to V_{CC}	V	Y
Operating temperature	T_a	-40 to 85	°C	
Output current	I_{OH}	-12	mA	$V_{CC} = 2.7\text{ V}$
		-24 ²	mA	$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
	I_{OL}	12	mA	$V_{CC} = 2.7\text{ V}$
		24 ²	mA	$V_{CC} = 3.0\text{ V to }5.5\text{ V}$
Input rise / fall time ^{*1}	t_r, t_f	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform : Refer to test circuit of switching characteristics.

2. duty cycle ≤ 50%

Electrical Characteristics

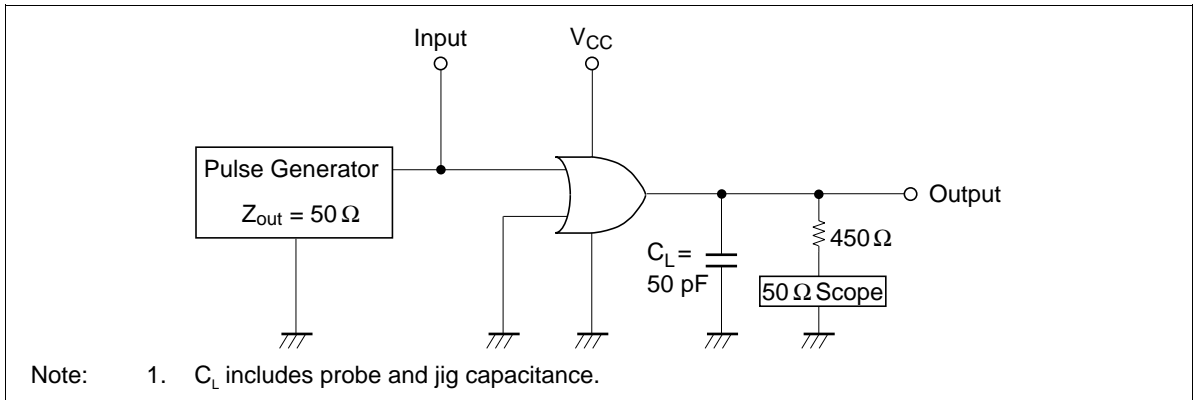
Item	Symbol	V_{CC} (V)	$T_a = -40\text{ to }85^\circ\text{C}$		Unit	Test Conditions
			Min	Max		
Input voltage	V_{IH}	2.7 to 3.6	2.0	—	V	
		4.5 to 5.5	$V_{CC} \times 0.7$	—	V	
	V_{IL}	2.7 to 3.6	—	0.8	V	
		4.5 to 5.5	—	$V_{CC} \times 0.3$	V	
Output voltage	V_{OH}	2.7 to 5.5	$V_{CC} - 0.2$	—	V	$I_{OH} = -100\ \mu\text{A}$
		2.7	2.2	—	V	$I_{OH} = -12\ \text{mA}$
		3.0	2.4	—	V	$I_{OH} = -12\ \text{mA}$
		3.0	2.0	—	V	$I_{OH} = -24\ \text{mA}$
		4.5	3.8	—	V	$I_{OH} = -24\ \text{mA}$
	V_{OL}	2.7 to 5.5	—	0.2	V	$I_{OL} = 100\ \mu\text{A}$
		2.7	—	0.4	V	$I_{OL} = 12\ \text{mA}$
		3.0	—	0.55	V	$I_{OL} = 24\ \text{mA}$
		4.5	—	0.55	V	$I_{OL} = 24\ \text{mA}$
		Input current	I_{IN}	0 to 5.5	—	±5.0
Quiescent supply current	I_{CC}	5.5	—	20	μA	$V_{IN} = V_{CC}\ \text{or GND}$
	ΔI_{CC}	3.0 to 3.6	—	500	μA	$V_{IN} = \text{one input at } (V_{CC} - 0.6)\text{V, other inputs at } V_{CC}\ \text{or GND}$

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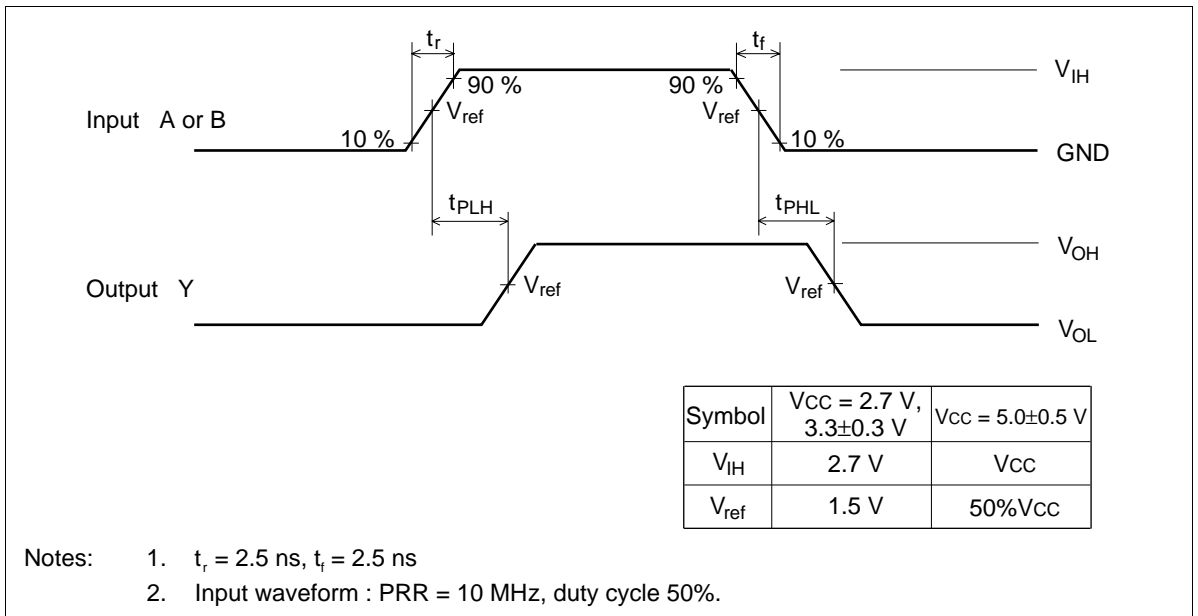
Switching Characteristics

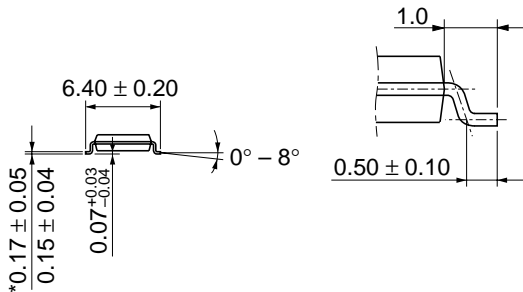
Item	Symbol	V _{CC} (V)	Ta = -40 to 85°C			Unit	From (Input)	To (Output)
			Min	Typ	Max			
Propagation delay time	t _{PLH}	2.7	—	4.5	7.0	ns	A or B	Y
	t _{PHL}	3.3±0.3	1.5	3.5	6.0	ns		
		5.0±0.5	—	3.0	5.0	ns		
Input capacitance	C _{IN}	2.7	—	3.0	—	pF		
Output capacitance	C _O	2.7	—	15.0	—	pF		

Test Circuit



Waveforms





*Dimension including the plating thickness
 Base material dimension

Hitachi Code	TTP-14D
JEDEC	—
EIAJ	—
Weight (reference value)	0.05 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL North America : <http://semiconductor.hitachi.com/>
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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